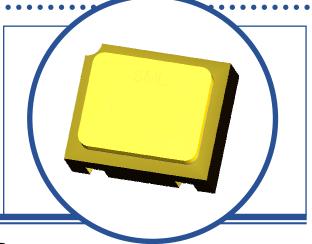
# SILICON EPITAXIAL PLANAR DIODE



### 1N6642CSM

- Low Leakage
- Fast Switching
- Low Forward Voltage
- Hermetic Ceramic Surface Mount Package
- Suitable for general purpose, switching applications.
- Screening Options Available



### ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C unless otherwise stated)

$V_{BR}$	Breakdown Voltage	100V	
$V_{RWM}$	Working Peak Reverse Voltag	75V	
$IO_{(1)}$	Average Rectified Output Cu	300mA	
I <sub>FSM</sub>	Surge Current, half sine wave	2.5A	
$PD^{(1)}$	Total Power Dissipation at	$T_A = 75$ °C	385mW
		Derate Above 75°C	3.08mW/°C
$P_{D}$	Total Power Dissipation at	$T_{SP} = 75^{\circ}C$	1.25W
		Derate Above 75°C	10mW/°C
TJ	Junction Temperature Range	-65 to +200°C	
T <sub>stg</sub>	Storage Temperature Range	-65 to +200°C	

#### THERMAL PROPERTIES

Symbols	Parameters	Min.	Тур.	Мах.	Units
R <sub><b>\theta</b>JA</sub> (PCB) <sup>(1)</sup>	Thermal Resistance, Junction To Ambient, On PCB			325	°C/W
R <sub>OJSP</sub>	Thermal Resistance, Junction To Solder Pads			100	°C/W

#### Notes

(1) PCB = FR4 – 0.0625 Inch (1.59mm), 1 Layer, 1.0-Oz Cu, horizontal, in still air.  $R_{AIA}$  with a defined PCB thermal resistance condition included, is measured at  $I_{O}$  = 300mA.

Semelab Limited reserves the right to change test conditions, parameter limits and package dimensions without notice. Information furnished by Semelab is believed to be both accurate and reliable at the time of going to press. However Semelab assumes no responsibility for any errors or omissions discovered in its use. Semelab encourages customers to verify that datasheets are current before placing orders.



## SILICON EPITAXIAL PLANAR DIODE 1N6642CSM



### **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise stated)

Symbols	Parameters	Test Conditions	5	Min.	Тур	Max.	Units		
V <sub>BR</sub>	Breakdown Voltage	I <sub>R</sub> = 100μA		100					
V <sub>F</sub> (2)	Forward Voltage	I <sub>F</sub> = 10mA				0.8			
		I <sub>F</sub> = 100mA				1.2	V		
		$I_F = 10 \text{mA}$ $T_A$	₁ = 150°C			0.8			
		$I_F = 100 \text{mA}$ $T_A$	$I_F = 100 \text{mA}$ $T_A = -55 ^{\circ} \text{C}$			1.2			
I <sub>R</sub>	Reverse Current	V <sub>R</sub> = 20V	V <sub>R</sub> = 20V			25	A		
		V <sub>R</sub> = 75V	V <sub>R</sub> = 75V			500	nA		
		V <sub>R</sub> = 20V	T <sub>A</sub> = 150°C			50	- μΑ		
		V <sub>R</sub> = 75V				100			

#### **DYNAMIC CHARACTERISTICS**

С	Capacitance	V <sub>R</sub> = 0V	f = 1.0MHz		5	nE
		V <sub>R</sub> = 1.5V			2.8	- p⊦
t <sub>rr</sub>	Reverse Recovery Time	$I_F = IR = 10mA$	$R_L = 100\Omega$		5	ns
		I <sub>REC</sub> = 1.0mA				

#### Notes

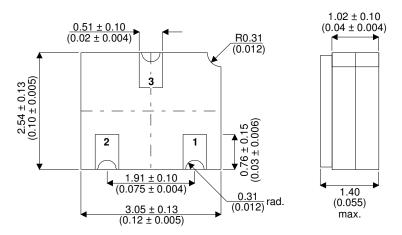
(2) Pulse Width  $\leq$  300us,  $\delta \leq$  2%

### SILICON EPITAXIAL PLANAR DIODE 1N6642CSM



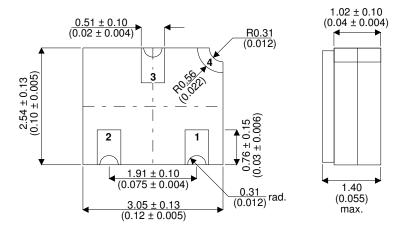
#### **MECHANICAL DATA**

Dimensions in mm (inches)



#### LCC1 (Underside View)

Pad 1 - Anode Pad 2 - N/C Pad 3 - Cathode



LCC1-4 (Underside View)

Pad 1 - Anode Pad 2 - N/C Pad 3 - Cathode Pad 4 - Lid Contact Ground \*

Note: If required, must be requested at time of order

Other Package Outlines may be available – Contact Semelab Sales to Enquire

Semelab Limited Cover Telephone +44 (0) 1455 556565

Coventry Road, Lutterworth, Leicestershire, LE17 4JB 5565 Fax +44 (0) 1455 552612 Email: sales@

Email: <u>sales@semelab-tt.com</u>

Website: http://www.semelab-tt.com

<sup>\*</sup> The additional contact provides a connection to the lid in the application. Connecting the metal lid to a known electrical potential stops deep dielectric discharge in space applications; see the Space Weather link <a href="https://www.semelab.co.uk/mil/lcc1\_4">www.semelab.co.uk/mil/lcc1\_4</a> on the Semelab web site. Package variant to be specified at order.

### SILICON EPITAXIAL PLANAR DIODE 1N6642CSM



#### **SCREENING OPTIONS**

Space Level (JQRS/ESA) and High Reliability options are available in accordance with the <u>High Reliability and Screening Options Handbook</u> available for download from the from the TT electronics Semelab web site.

ESA Quality Level Products are based on the testing procedures specified in the generic ESCC 5000 and in the corresponding part detail specifications.

Semelabs QR216 and QR217 processing specifications (JQRS), in conjunction with the companies ISO 9001:2000 approval present a viable alternative to the American MIL-PRF-19500 space level processing.

QR217 (Space Level Quality Conformance) is based on the quality conformance inspection requirements of MIL-PRF-19500 groups A (table V), B (table VIa), C (table VII) and also ESA / ESCC 5000 (chart F4) lot validation tests.

QR216 (Space Level Screening) is based on the screening requirements of MIL-PRF-19500 (table IV) and also ESA /ESCC 5000 (chart F3).

JQRS parts are processed to the device data sheet and screened to QR216 with conformance testing to Q217 groups A and B in accordance with MIL-STD-750 methods and procedures.

Additional conformance options are available, for example Pre-Cap Visual Inspection, Buy-Off Visit or Data Packs. These are chargeable and must be specified at the order stage (See Ordering Information). Minimum order quantities may apply.

Alternative or additional customer specific conformance or screening requirements would be considered. Contact Semelab sales with enquires.

#### **MARKING DETAILS**

Screened parts are typically marked with specification number, serial number (or week of seal) as shown in the example below. All non screened parts are printed with three characters only eg. 642.

Customer specific marking requirements can be arranged at time of order but is approximately limited to two lines of 7 Characters. This is to ensure text remains readable..

#### Example Marking:



#### **ORDERING INFORMATION**

Part number is built from part and screening level. The part number can be extended to include the additional options as shown below.

Type – See Electrical Stability Characteristics Table Package Variant – See Mechanical Data Screening Level – See Screening Options (ESA / JQRS)

#### Additional Options:

.CVP
.CVB
.DA
.SS
.SEM
.XRAY
.RAD
.GRPB
.GBDM (12 pieces)
.GRPC
.GCDE (12 pieces)
.GCDM (6 pieces)
.LVT1
.L1DE (15 pieces)
.L1DM (15 pieces)
.LVT2
.L2D (15 pieces)
.LVT3
.L3D (5 pieces)

Additional Option Notes:

- All 'Additional Options' are chargeable and must be specified at order stage
- 2) When Group B,C or LVT is required, additional electrical and mechanical destructive samples must be ordered
- All destructive samples are marked the same as other production parts unless otherwise requested.

#### Example ordering information:

The following example is for the part with, JQRS screening, additional Group C conformance testing and a Data pack.

#### Part Numbers:

1N6642CSM-JQRS (Include quantity for flight parts)
1N6642CSM-JQRS.GRPC (chargeable conformance option)
1N6642CSM-JQRS.GCDE (charge for destructive parts)
1N6642CSM-JQRS.GCDM (charge for destructive parts)
1N6642CSM-JQRS.DA (charge for Data pack)

Customers with any specific requirements (e.g. marking, package or screening) may be supplied with a similar alternative part number (there is maximum 20 character limit to part numbers). Requirements for deep dielectric discharge variant (LCC1-4) must be specified at time of order. Contact Semelab sales with all enquiries

Website: http://www.semelab-tt.com

High Reliability and Screening Options Handbook link: http://www.semelab.co.uk/pdf/misc/documents/hirel\_and\_screening\_options.pdf